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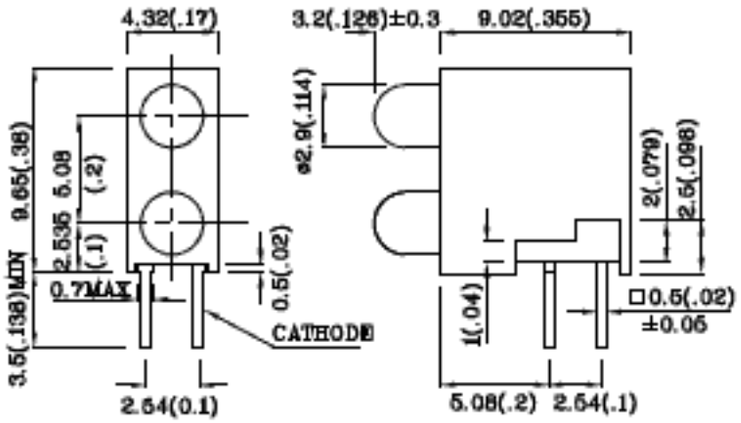
Part Number: **XYN2LUG11D**

T-1 (3mm) BI-LEVEL LED INDICATOR

Features

- PRE-TRIMMED LIADS FOR PC MOUNTING.
- I.C.COMPATIBLE.
- WIDE VIEWING ANGLE.
- BLACK CASE ENHANCES CONTRAST RATIO.
- HIGH RELIABILITY LIFE MEASURED IN YEARS.
- UL RATING : 94V-0.
- HOUSING MATERIAL:TYPE 66 NYLON.
- RoHS COMPLIANT.



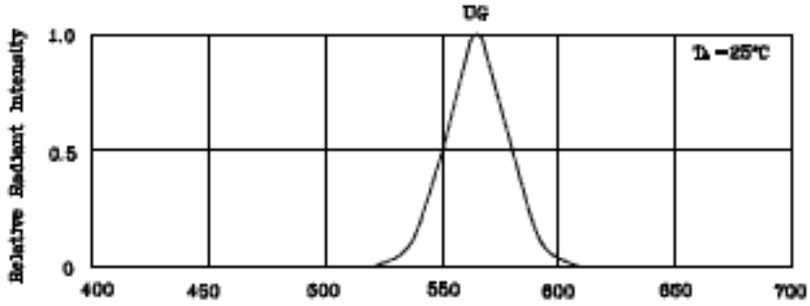
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.

Absolute maximum ratings (T_A=25°C)		UG (GaP)	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Forward Current (peak) 1/10Duty Cycle 0.1ms Pulse Width	i_{FS}	140	mA
Power Dissipation	P_T	105	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Lead Solder Temperature [2mm below package base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm below package base]	260°C For 5 Seconds		

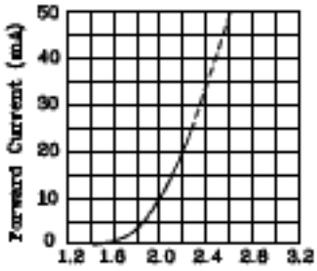
Operating Characteristics (T_A=25°C)		UG (GaP)	Unit
Forward Voltage (typ.) (I_F=10mA)	V_F	2.0	V
Forward Voltage (max.) (I_F=10mA)	V_F	2.5	V
Reverse Current (V_R=5V)	I_R	10	uA
Wavelength of Peak Emission (I_F=10mA)	λ P	565	nm
Wavelength of Dominant Emission (I_F=10mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (I_F=10mA)	Δλ	30	nm
Capacitance (V_F=0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=10mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XYN2LUG11D	Green	GaP	Green Diffused	8	19	565	40°

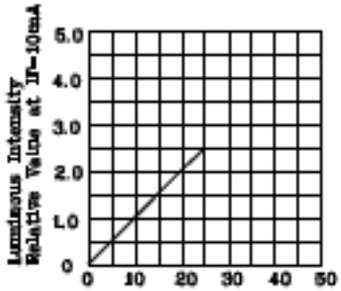


RELATIVE INTENSITY Vs. WAVELENGTH

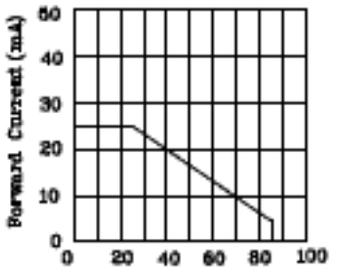
❖ UG



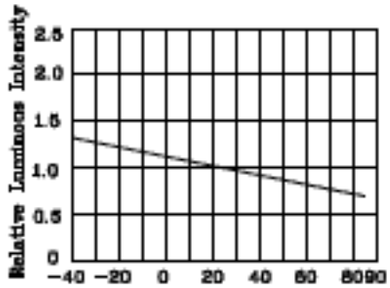
FORWARD CURRENT Vs.
FORWARD VOLTAGE



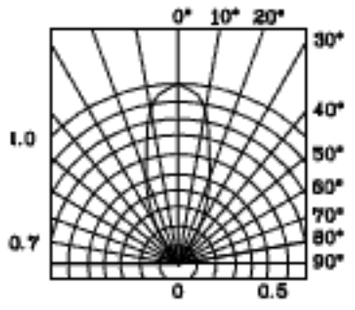
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

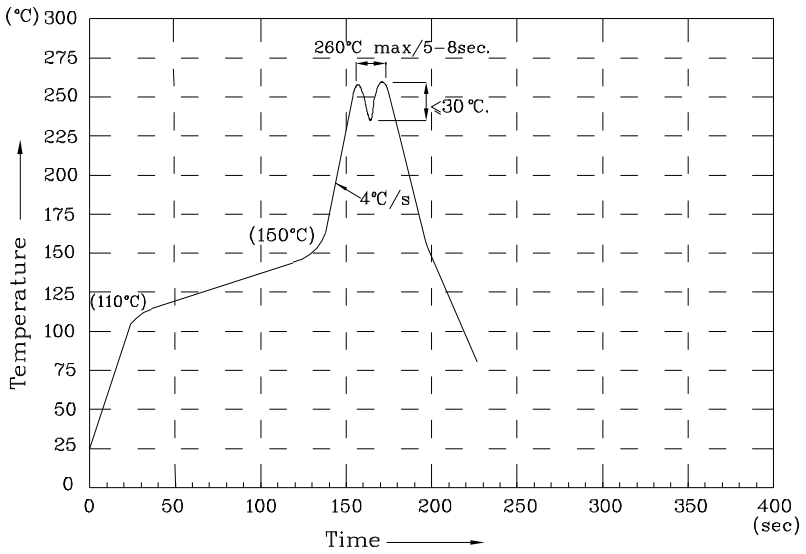


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245℃~260℃. The maximum soldering temperature should be less than 260℃.
2. Do not apply stress on epoxy resins when temperature is over 85 degree℃.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous Intensity: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.